503730879 03/10/2016

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3777521

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YEONG-SHENG LEE	03/04/2016

RECEIVING PARTY DATA

Name:	VIA ALLIANCE SEMICONDUCTOR CO., LTD.
Street Address:	ROOM 301, NO.2537, JINKE ROAD, ZHANGJIANG HI-TECH PARK
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	201203

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15066205

CORRESPONDENCE DATA

Fax Number: (404)521-4286

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6784838899

Email: dan.mcclure@mqrlaw.com

Correspondent Name: MCCLURE, QUALEY & RODACK, LLP Address Line 1: 3100 INTERSTATE NORTH CIRCLE

Address Line 2: **SUITE 150**

Address Line 4: ATLANTA, GEORGIA 30339

ATTORNEY DOCKET NUMBER:	252229-1460
NAME OF SUBMITTER:	DANIEL R. MCCLURE
SIGNATURE:	/Daniel R. McClure/
DATE SIGNED:	03/10/2016

Total Attachments: 1

source=00332638#page1.tif

PATENT REEL: 037944 FRAME: 0916 503730879

ASSIGNMENT

WHEREAS, Yeong-Sheng LEE
WHEREAS, Yeong-Sheng LEE hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as
described and set forth in the below identified application for United States Letters Patent:
Title: PRE-DRIVER FOR DRIVING LOW VOLTAGE DIFFERENTIAL SIGNALING
(LVDS) DRIVING CIRCUIT
Filed: Serial No.
Executed on:
WHEREAS, <u>VIA Alliance Semiconductor Co., Ltd.</u> of <u>Room 301, No.2537</u> , <u>Jinke Road</u> , <u>Zhangjiang Hi-Tech Park, Shanghai 201203</u> , <u>P.R. China</u> hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;
NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.
Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignec's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.
IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.
March 4, 2016
Yeong-Sheng LEE Date

PATENT REEL: 037944 FRAME: 0917

RECORDED: 03/10/2016